

MN74HCT4538/MN74HCT4538S (Under Development)

Dual Precision Retriggerable Monostable Multivibrator (TTL Input)







■ Outline





The MN74HCT4538/MN74HCT4538S is a resettable and retriggerable monostable multivibrator. This multivibrator is triggerable at the rising edge of the A input and at the falling edge of the B input. A wide and accurate range of the output pulse width is obtainable since the output pulse width and the accuracy are decided by the time constants of the external condenser C_{ext} and the external resistor R_{ext} .

Owing to the silicon gate CMOS process, this multivibrator has realized low power consumption and high noise immunity equivalent to those of a standard CMOS and the operation speed as high as of an LS TTL, and can directly ten LS TTL inputs.

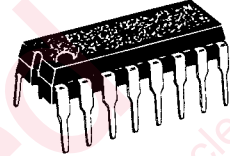
To protect the input and output against electrostatic breakdown, a resistor and a diode are used for the V_{CC} and the GND. The pin configuration and the function are the same as those of the standard 54LS/74LS logic family.

■ Truth Table

CLEAR	Input		Output	
	A	B	Q	\bar{Q}
L	X	X	L	H
H	L			
H		H		

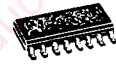
Note) H : High level
 L : Low level
 X : "H" or "L" either will do.
 : Trailing from "H" to "L"
 : Leading from "L" to "H"
 : One piece of "H" level pulse
 : One piece of "L" level pulse

P-3



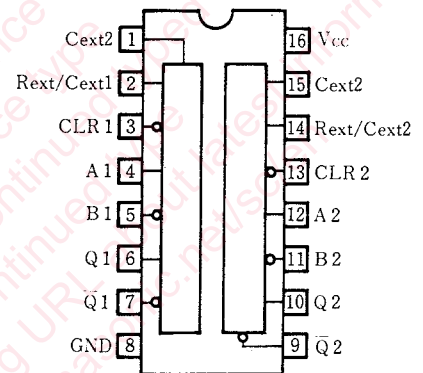
16-pin plastic DIL package

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16-pin PANAFLAT package (SO-16D)

Pin Configuration



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